



2SJ670 — P-Channel Silicon MOSFET

General-Purpose Switching Device Applications

Features

- Low ON-resistance.
- Ultrahigh-speed switching.
- 4V drive.

Specifications

Absolute Maximum Ratings at $T_a=25^\circ\text{C}$

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	V_{DS}		-100	V
Gate-to-Source Voltage	V_{GS}		± 20	V
Drain Current (DC)	I_D		-1.5	A
Drain Current (Pulse)	I_{DP}	$PW \leq 10\mu\text{s}$, duty cycle $\leq 1\%$	-6	A
Allowable Power Dissipation	P_D	Mounted on a ceramic board (600mm ² X0.8mm)	1.5	W
		$T_c=25^\circ\text{C}$	3.5	W
Channel Temperature	T_{ch}		150	$^\circ\text{C}$
Storage Temperature	T_{stg}		-55 to +150	$^\circ\text{C}$

Electrical Characteristics at $T_a=25^\circ\text{C}$

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Drain-to-Source Breakdown Voltage	$V_{(BR)DSS}$	$I_D=-1\text{mA}$, $V_{GS}=0\text{V}$	-100			V
Zero-Gate Voltage Drain Current	I_{DSS}	$V_{DS}=-100\text{V}$, $V_{GS}=0\text{V}$			-1	μA
Gate-to-Source Leakage Current	I_{GSS}	$V_{GS}=\pm 16\text{V}$, $V_{DS}=0\text{V}$			± 10	μA
Cutoff Voltage	$V_{GS(off)}$	$V_{DS}=-10\text{V}$, $I_D=-1\text{mA}$	-1.2		-2.6	V
Forward Transfer Admittance	$ y_{fs} $	$V_{DS}=-10\text{V}$, $I_D=-0.8\text{A}$	1.3	2.3		S
Static Drain-to-Source On-State Resistance	$R_{DS(on)1}$	$I_D=-0.8\text{A}$, $V_{GS}=-10\text{V}$		410	535	$\text{m}\Omega$
	$R_{DS(on)2}$	$I_D=-0.8\text{A}$, $V_{GS}=-4\text{V}$		530	745	$\text{m}\Omega$
Input Capacitance	C_{iss}	$V_{DS}=-20\text{V}$, $f=1\text{MHz}$		535		pF
Output Capacitance	C_{oss}	$V_{DS}=-20\text{V}$, $f=1\text{MHz}$		43		pF
Reverse Transfer Capacitance	C_{rss}	$V_{DS}=-20\text{V}$, $f=1\text{MHz}$		31		pF
Turn-ON Delay Time	$t_{d(on)}$	See specified Test Circuit.		9		ns
Rise Time	t_r	See specified Test Circuit.		4.5		ns
Turn-OFF Delay Time	$t_{d(off)}$	See specified Test Circuit.		62		ns
Fall Time	t_f	See specified Test Circuit.		34		ns

Marking : NA

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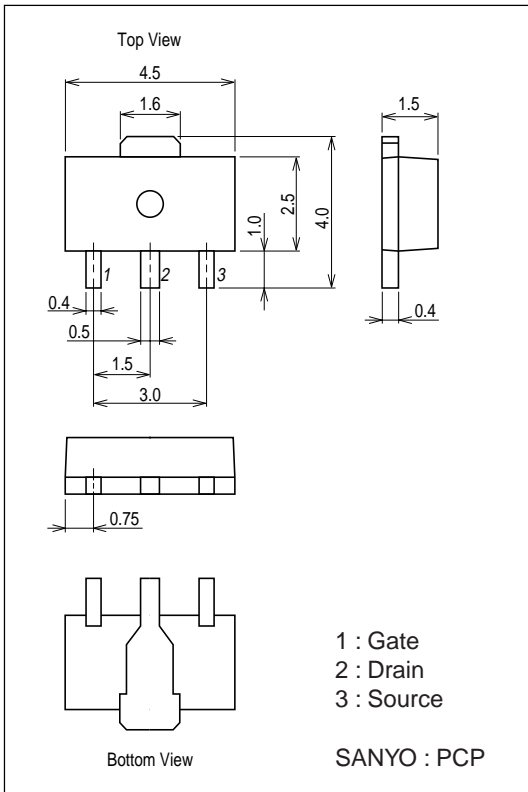
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Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Total Gate Charge	Qg	$V_{DS}=-50V, V_{GS}=-10V, I_D=-1.5A$		11		nC
Gate-to-Source Charge	Qgs	$V_{DS}=-50V, V_{GS}=-10V, I_D=-1.5A$		2.6		nC
Gate-to-Drain "Miller" Charge	Qgd	$V_{DS}=-50V, V_{GS}=-10V, I_D=-1.5A$		2		nC
Diode Forward Voltage	V_{SD}	$I_S=-1.5A, V_{GS}=0V$		-0.83	-1.2	V

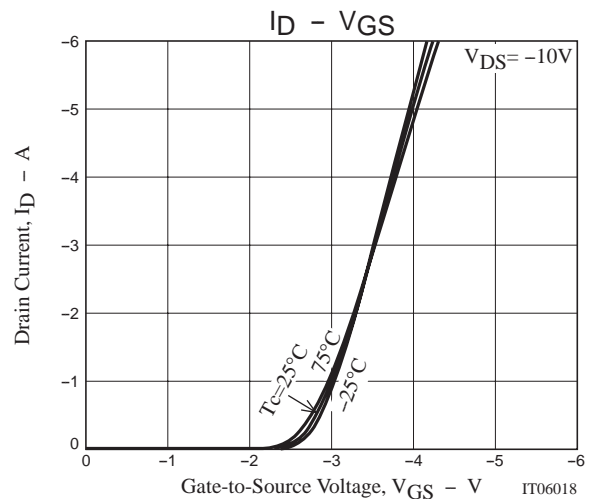
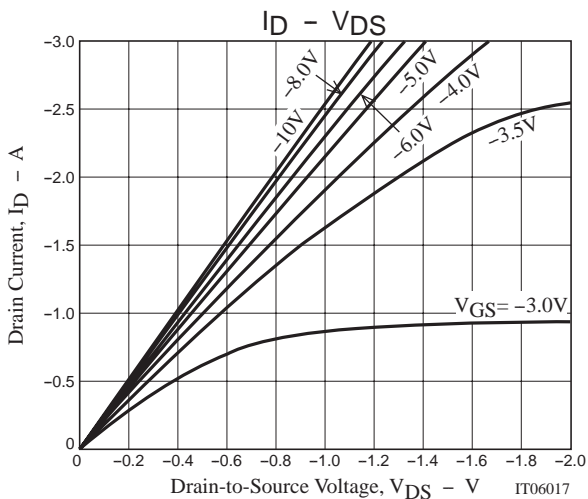
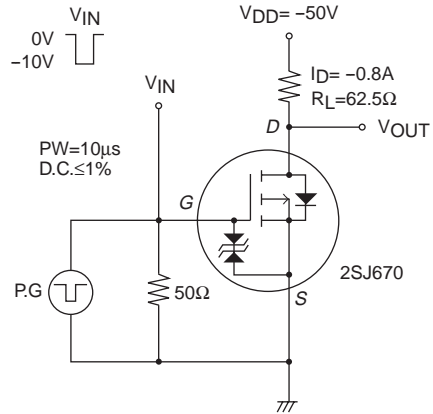
Package Dimensions

unit : mm (typ)

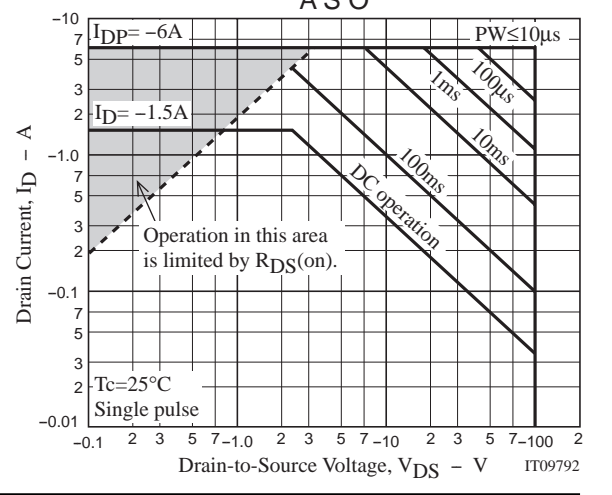
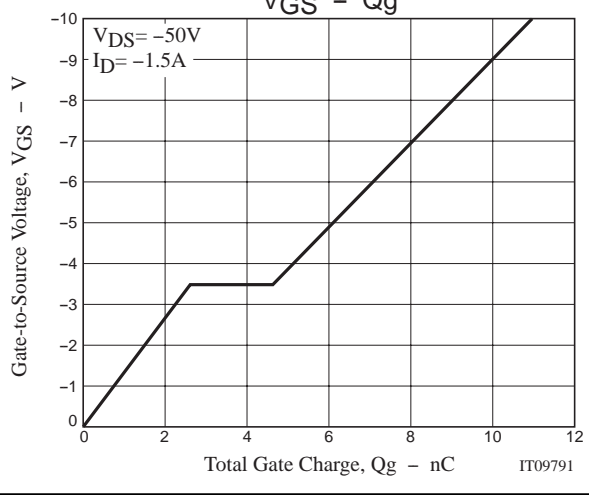
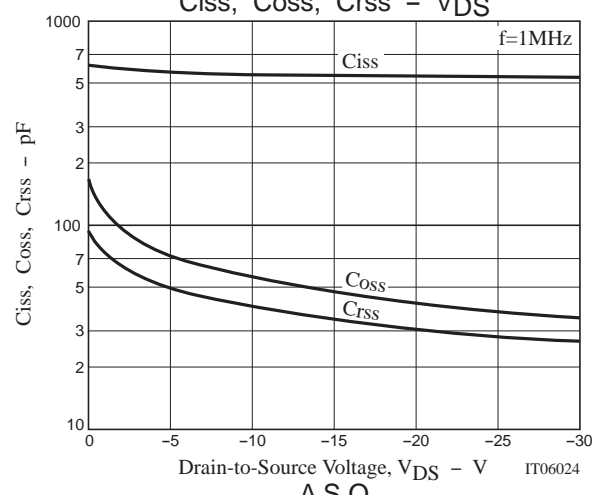
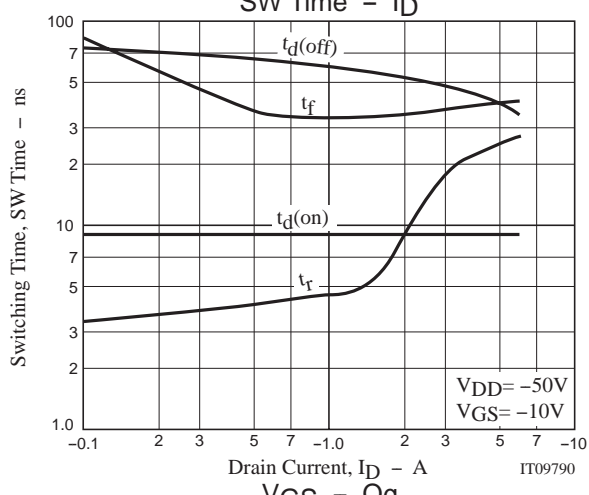
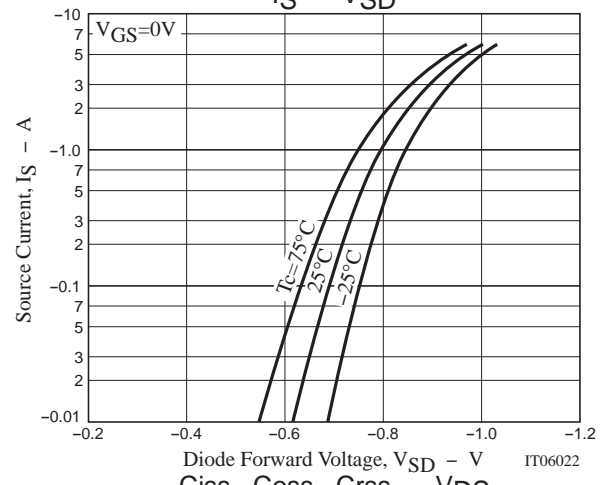
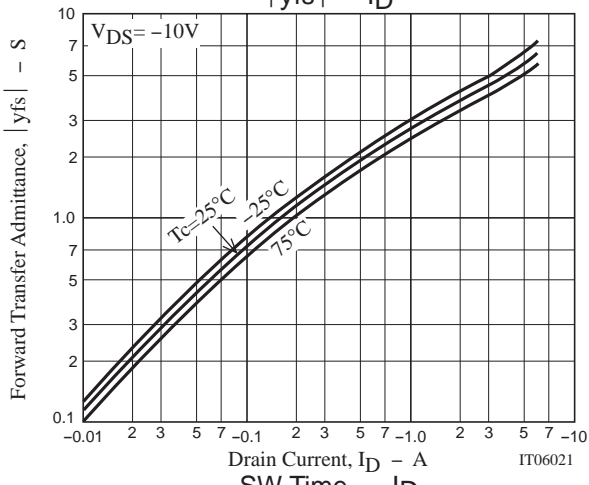
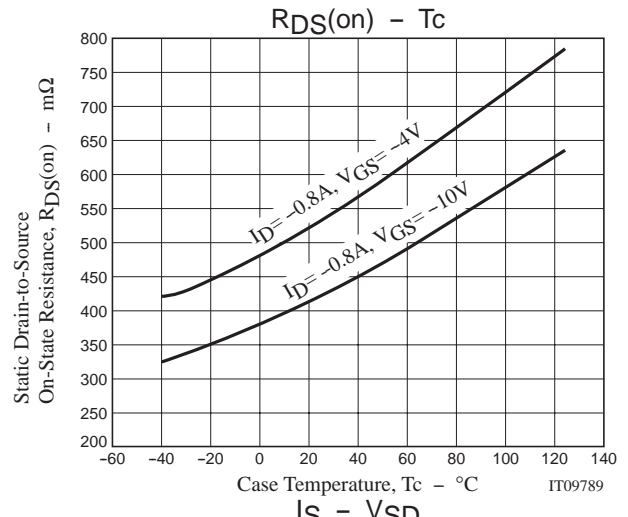
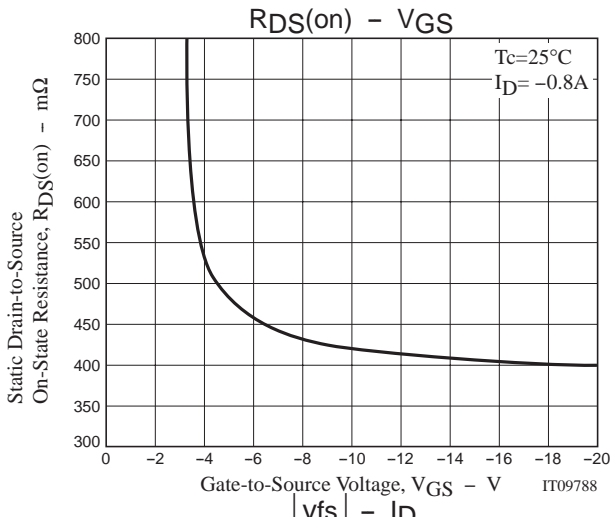
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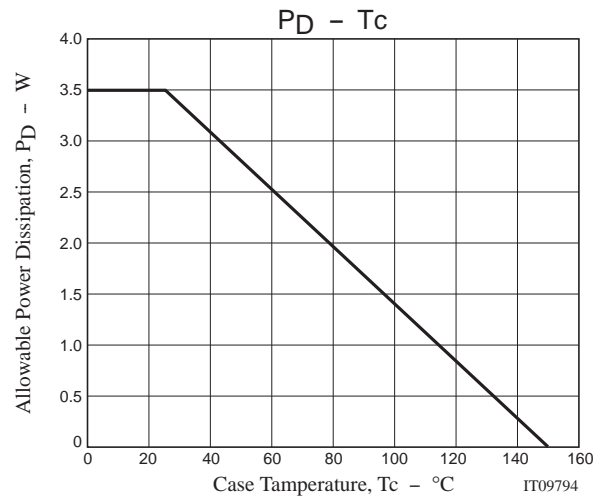
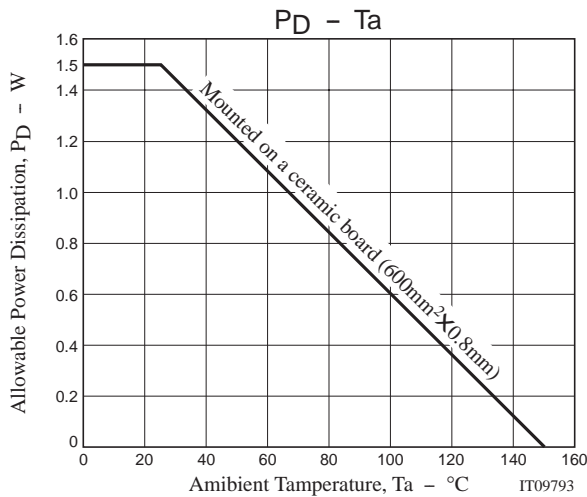


Switching Time Test Circuit



2SJ670





Note on usage : Since the 2SJ670 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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